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** CONTINUING DATA ***** *NONE*** FOREIGN APPLICATIONS ***** *NONE*

IF REQUIRED, FOREIGN FILING LICENSE GRANTED

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Foreign Priority claimed 35 USC 119 (a-d) conditions met Verified and Acknowledged	<input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> Met after Allowance <i>Sam Nuthrick</i> <i>TWH</i> Examiner's Signature Initials	STATE OR COUNTRY SINGAPORE	SHEETS DRAWING 1	TOTAL CLAIMS 9	INDEPENDENT CLAIMS 2
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ADDRESS

000002352

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TITLE

Mold FOR ENCAPSULATING A SEMICONDUCTOR CHIP

FILING FEE

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840

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